

January 4, 2001

To: Commissioner of Patents and Trademarks
Washington, D.C. 20231

Fr: George O. Saile Reg. No. 19,572
20 McIntosh Drive
Poughkeepsie, N.Y. 12603

Subject:

Divisional Patent Application of
Serial No.: 09/442,497 11/18/99
SHENG-HSIUNG CHEN
METHOD OF IMPROVING COPPER PAD ADHESION

PRELIMINARY AMENDMENT

Dear Sir:

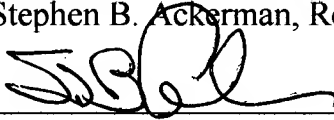
This is a preliminary amendment for the above referenced Divisional Patent Application. Please amend the above identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on January 4, 2001.

Stephen B. Ackerman, Reg. No. 37,761

Signature/Date



1/4/01